

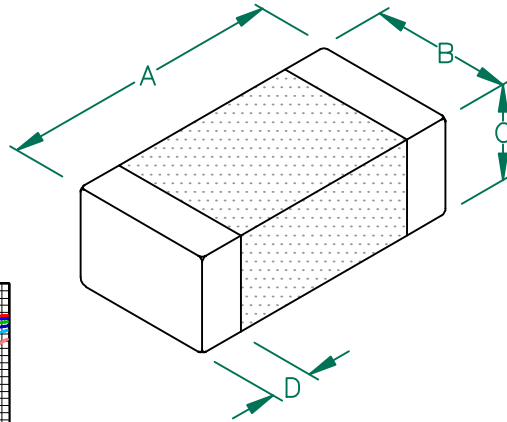


MI1206K260R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

A	3.20 [.126]	+ 0.20 [.008]
B	1.60 [.063]	+ 0.20 [.008]
C	1.10 [.043]	+ 0.20 [.008]
D	0.51 [.020]	+ 0.25 [.010]

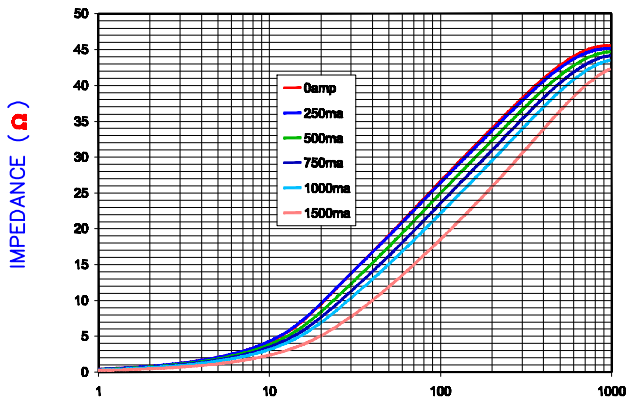


ELECTRICAL CHARACTERISTICS:

	Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	26		
Minimum	20		
Maximum	33	0.060	1500 mA

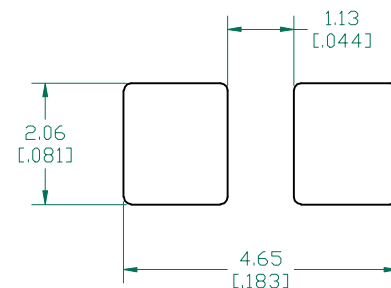
- NOTES: UNLESS OTHERWISE SPECIFIED
1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
 3. TERMINATION FINISH IS 100% TIN.

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS



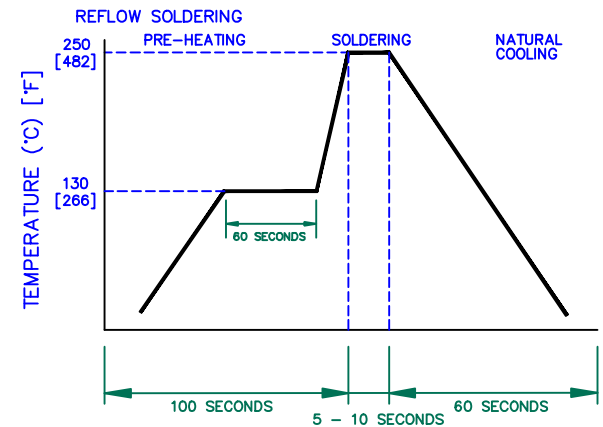
FREQUENCY (MHz)

LAND PATTERNS FOR REFLOW SOLDERING

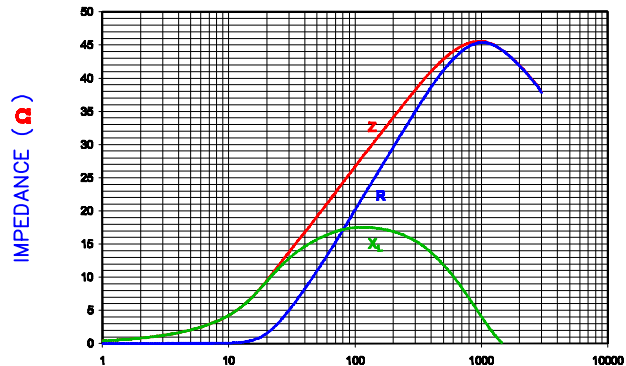


(For wave soldering, add 0.762 (.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS



|Z| , R, AND X vs. FREQUENCY



FREQUENCY (MHz)



AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 3298



DIMENSIONS ARE IN mm [INCHES]				This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.			
				Laird TECHNOLOGIES			
PROJECT/PART NUMBER:				REV	PART TYPE:	DRAWN BY:	
MI1206K260R-10				B	CO-FIRE	JRK	
B	UPDATE COMPANY LOGO ADD ROHS	8/20/08	JRK	DATE:	04/13/04	SCALE:	NTS
A	ORIGINAL DRAFT	04/13/04	JRK	GAD #		SHEET:	
REV	DESCRIPTION	DATE	INT	M1206K260R-10-B		TOOL #	-
						2 of 2	